

# 2SC3941

## Silicon NPN triple diffusion planar type

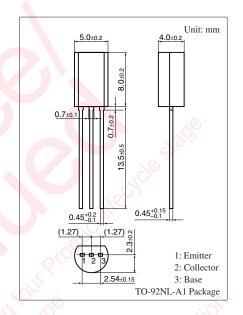
For high breakdown voltage general amplification For small TV video output Complementary to 2SA1858

### ■ Features

- High collector-emitter voltage (Base open) V<sub>CEO</sub>
- High transition frequency f<sub>T</sub>
- Allowing supply with the radial taping

### ■ Absolute Maximum Ratings $T_a = 25^{\circ}C$

Symbol	Rating	Unit	
$V_{CBO}$	300	V	
V <sub>CEO</sub>	300	V	
$V_{\rm EBO}$	7	V	
$I_{\rm C}$	70	mA	
I <sub>CP</sub>	100	mA	
P <sub>C</sub>	1	W	
Tj	150	°C O	
T <sub>stg</sub>	-55 to +150	°C	
	$\begin{array}{c} V_{CBO} \\ V_{CEO} \\ V_{EBO} \\ I_{C} \\ I_{CP} \\ P_{C} \\ T_{j} \end{array}$	V <sub>CBO</sub> 300 V <sub>CEO</sub> 300 V <sub>EBO</sub> 7 I <sub>C</sub> 70 I <sub>CP</sub> 100 P <sub>C</sub> 1 T <sub>j</sub> 150	



## ■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C

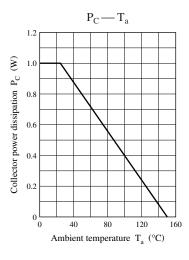
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 100 \mu\text{A},  I_B = 0$	300	95		V
Emitter-base voltage (Collector open)	$V_{\rm EBO}$	$V_{EBO}$ $I_E = 1 \mu A, I_C = 0$				V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 100 \text{ V}, I_{E} = 0$	1.7		2	μΑ
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	30		220	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$	50	80		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		4	8	pF
Storage time	t <sub>stg</sub>	$I_C = 100 \text{ mA}, I_{B1} = 10 \text{ mA}, I_{B2} = 0$		2.5		μs

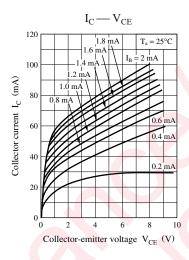
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

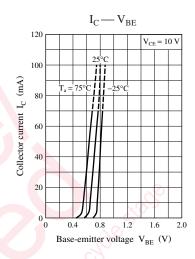
#### 2. \*: Rank classification

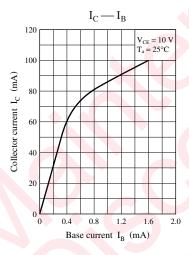
Rank	Р	Q	R
$h_{FE}$	30 to 100	60 to 150	100 to 220

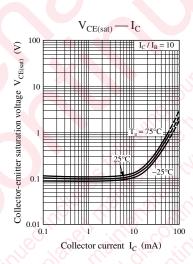
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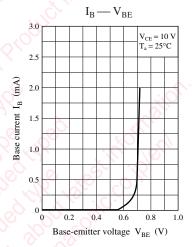


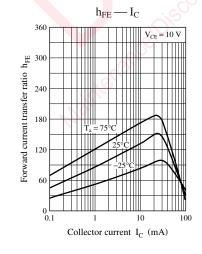


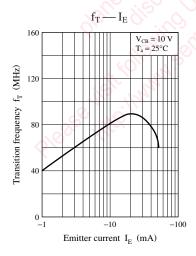


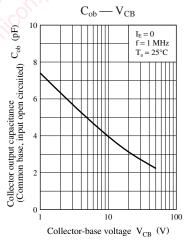




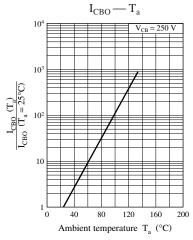


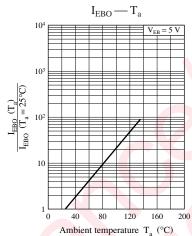


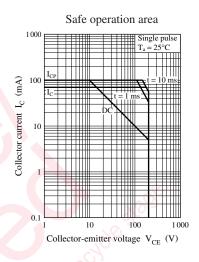




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